### **REMARKS**

# Entry of Amendments

As Applicants are filing a RCE herewith, the amendment (Amendment C) filed October 8, 2007 and this amendment should be entered and considered by the Examiner at this time.

Applicants will address each of the Examiner's objections and rejections in the order in which they appear in the Final Rejection, and will also address the Examiner's comments in the Advisory Action.

# Claim Objections

In the Final Rejection, the Examiner objects to Claim 6 for informalities and particularly, objects to the phrase "irradiation of the plasma."

In order to overcome this objection, Applicants have amended Claim 6 to recite "irradiation with the plasma," as the Examiner suggests. It is respectfully submitted that this overcomes the Examiner's objection, and it is requested that the objection be withdrawn.

#### Claim Rejections - 35 USC §103

# Seki in view of Lewis

The Examiner rejects Claims 1, 3-4, and 6-7 under 35 USC §103(a) as being unpatentable over Seki et al. (EP 0989778) in view of Lewis et al. (US 5,272,979). This rejection is respectfully traversed.

In order to advance the prosecution of this application, Applicants are amending independent

Claim 1 to clarify the claimed invention.

In Amendment C, Applicants amended Claim 1 to recite "forming a liquid-repellent thin film to a liquid composition on an insulating surface" and "forming a pattern by applying a drop comprising the liquid composition to the selected portions from a second nozzle."

However, in the Advisory Action, the Examiner objects to this claim language as creating a 112 clarity problem. While Applicants disagree, in order to advance the prosecution of this application, Applicants are amending Claim 1 to recite "forming a liquid-repellent thin film to a liquid composition on an insulating surface, the liquid-repellent thin film being repellent to a liquid composition." Applicants are also amending Claim 1 to recite "forming a pattern by applying a drop of the liquid composition to the selected portion from a second nozzle surface." It is respectfully submitted that as amended, there is no clarity problem and the amendment is clearly supported by the application as filed.

As amended, Claim 1 clearly claims that a selected portion of the liquid repellent thin film has a liquid affinity to the liquid composition by being irradiated with plasma from a first nozzle. Then, a drop of the liquid composition is applied to the selected portion having the liquid affinity to the liquid composition. As a result, in the present invention, a liquid affinity region and a liquid-repellent region are formed on the thin film without forming other elements such as a bank.

In contrast, <u>Seki</u> appears to disclose that bank is formed over the substrate, and then, the substrate is irradiated with oxygen plasma to raise liquid affinity. Then, the bank is irradiated with fluorine based plasma to raise liquid repellency. This is clearly different than the method of the

<sup>&</sup>lt;sup>1</sup> Applicants are also amending Claim 3 to clarify the claim to recite that the liquid composition comprises...which should overcome the Examiner's objection in the Advisory Action to this claim.

claimed invention. Additionally, the Examiner contends that "[i]t would have been obvious to one of ordinary skilled in the art that as Seki et al. is providing teachings concerning plasma is that selectively affect the surface affinity to subsequent coating, but do not discuss particular plasma details, to the two prior art plasma techniques that create like differential affinity treatments, where the process of Lewis et al. provide such techniques which would have been expected to be equivalently effective in the process of Seki et al., as Lewis et al. demonstrates their techniques effectiveness for multiple different coatings inclusive..., thus showing the expected general of effectiveness of such affinity treatments via plasma from a nozzle." Applicants respectfully disagree and submit that the combination of references to arrive at the claimed invention is improper.

<u>Seki</u> describes "a series of surface modification treatments refers to a process, described below, for, most suitably, applying plasma treatments, described below, <u>all at one time</u> to a substrate wherein banks made of an organic material are formed on bank forming surfaces configured by an inorganic material" (emphasis added) in [0041]. Hence, it appears that there is no reason or need to perform the plasma treatments allegedly disclosed in <u>Lewis</u> to <u>Seki</u> since an inorganic surface to be treated by plasma in <u>Seki</u> has banks made of an organic material which are subsequently made to be non-affinity toward fluids containing polar molecules.

KSR v. Teleflex (US 4-30-2007) states that it is important "to identify a reason that would have prompted a person of ordinary skill in the relevant field to combine the elements in the way the claimed new invention does." 127 S. Ct. 1727, 1741 (2007). Applicants submit that there is no reason that would prompt one skilled in the art to combine <u>Seki</u> and <u>Lewis</u> to arrive at the claimed invention.

Therefore, the rejection is improper.

Hence, <u>Seki</u> and <u>Lewis</u> do not disclose or suggest the method of independent Claim 1, the combination of references is improper, and Claim 1 and those claims dependent thereon are patentable over the cited references.

Accordingly, it is respectfully requested that this rejection be withdrawn.

#### Seki in view of Lewis and further in view of Di Dio

The Examiner also rejects Claims 2, 5, and 16-18 under 35 USC §103(a) as being unpatentable over Seki et al. in view of Lewis et al. and further in view of Di Dio (US 2004/0152329). This rejection is also respectfully traversed.

In Amendment C and in this amendment, Applicants have amended independent Claim 2 for clarification purposes, in a similar manner as Claim 1 discussed above<sup>2</sup>. Hence, for at least the reasons discussed above, Claim 2 is also patentable over <u>Seki</u> and <u>Lewis</u>. Further, even if <u>Di Dio</u> is combined to <u>Seki</u> and <u>Lewis</u>, the claimed steps of "selectively forming a groove or a hole in a surface of the thin film having an affinity for a liquid composition" and "forming a pattern by applying a drop comprising the liquid composition to the groove or the hole" are still not obtained.

Therefore, even if it were proper to combine the references (which it is not as explained above), none of the cited references or combination thereof disclose or suggest the method of independent Claim 2, and Claim 2 and those claims dependent thereon are patentable over the cited references.

Accordingly, it is respectfully requested that this rejection be withdrawn.

<sup>&</sup>lt;sup>2</sup> The amendments herein should overcome the Examiner's objection in the Advisory Action to claims 2 and 16.

#### Yoshikawa in view of Lewis

The Examiner also rejects Claims 1-4, 6-7, and 14-16 under 35 USC §103(a) as being unpatentable over Yoshikawa et al. (US 6,228,435) in view of Lewis et al. This rejection is also respectfully traversed.

In particular, the examiner alleges that it "would have been obvious to one of ordinary skill in the art to employ a plasma apparatus such as taught by Lewis et al. (979) which teaches the capability of direct writing type plasma treatment for affinity providing the advantageous capability of more precise patterning due to the selective nature of the direct write technique, thus motivating employed such an alternative with improved resolution or versatility in patterning is desired."

However, <u>Yoshikawa</u> describes that "oxygen gas is introduced into the vacuum container to produce oxygen plasma, to which the surface of the light-transmitting base, wherein the light-shielding portions have been formed between the pixels patterned in advance, is then exposed..." (col. 5, lines 33-37). Hence, it appears that there is no reason or need to perform the plasma treatments from <u>Lewis</u> as the thin metal portions in <u>Yoshikawa</u> retain good water repellency while exposed glass portions become hydrophilic.

Therefore, the combination of references is improper and it is respectfully requested that this rejection be withdrawn.

# **Double Patenting**

The Examiner also has the following rejections for double patenting:

A. Claims 1-7, 16-18 and 23-30 are rejected on the ground of nonstatutory obviousness-type double patenting as being unpatentable over Claims 1-10 of U.S. 7,226,819 (Maekawa et al.) in view of Lewis et al. '979.

B. Claims 1-6, 16-18 and 23-30 are provisionally rejected on the ground of nonstatutory obviousness-type double patenting over Claims 1-35 or 1-22, 28-37, 44-47 of copending Application Nos. 10/575,492, or 11/025,192, respectively in view of Lewis '979.

These rejections are respectfully traversed.

While Applicants traverse these rejections, it is respectfully requested that these rejections be held in abeyance until the prior art rejections are overcome and the claims are in their final form.

# Dependent Claims 5, 18, 30 and 7, 29

In the Advisory Action, the examiner objects to Claims 5, 18, 30 and 7, 29 as not being amended to correspond to the language in the independent claims. Accordingly, Applicants have amended Claims 5, 18, 30 and 7 and 29 to correspond to the independent claims which should overcome the Examiner's objection.

#### Independent Claim 23

Independent Claim 23 has been amended in a similar manner to Claim 2 which should overcome the Examiner's objection in the Advisory Action to this claim.

#### Conclusion

It is respectfully submitted that the present application is in a condition for allowance and should be allowed.

If any fee should be due for this amendment, the extension of time, or the RCE, please charge our deposit account 50/1039.

# Favorable reconsideration is earnestly solicited.

Respectfully submitted,

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